





Ultra Low Profile 0603 RF Crossover



Description:

The (patent pending) is an ultra-small low profile crossover that enables the transition of two intersecting RF traces in an easy to use industry standard SMT package. The 0603 crossover is ideal for any critical applications where layout and available space are a premium and resorting to addition PWB layers and larger overall footprints are unacceptable. With low insertion loss and high isolation packaged with cost in mind, this novel component delivers.

The X0060L7575AHF is available on tape and reel for pick and place high volume manufacturing. All of the Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability. All parts have been subjected to rigorous qualification testing and units are 100% RF tested.

Detailed Electrical Specifications: Specifications subject to change without notice.

		ROOM (25°C)			
Features:	Parameter	Min.	Тур.	Мах	Unit
 0 - 2500 MHZ. 0 7mm Height Profile 	Frequency	0		2500	MHz
 75 Ohm RF-RF Crossover 	Port Impedance		75		Ω
All Wireless Frequencies	Return Loss	19	21		dB
Low Insertion Loss	Insertion Loss		0.1	0.15	dB
High Isolation	Isolation (cross-talk)				
Surface Mountable Tana & Baal	0 – 700 MHz	44	52		dB
Non-conductive Surface	700 - 1700 MHz	40	47		dB
RoHS Compliant	1700 - 2500 MHz	38	43		dB
Halogen Free	Power Handling			2	Watts
	Operating Temperature	-55		+85	°C

Outline Drawing:



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X0060L7575AHF Rev D

Typical Performance: 500 MHz to 3000 MHz





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Mounting Configuration:

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertion loss, Isolation and VSWR may not meet published specifications.

All of the Xinger components are constructed from organic PTFE based composites which possess excellent electrical and mechanical stability. Xinger components are compliant to a variety of ROHS and Green standards and ready for Pb-free soldering processes. Pads are Gold plated with a Nickel barrier.

An example of the PCB footprint used in the testing of these parts is shown below. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.



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Packaging and Ordering Information:



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